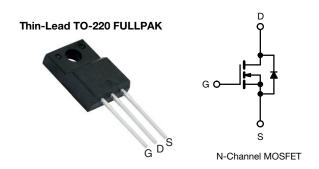
COMPLIANT

HALOGEN

FREE



## **E Series Power MOSFET**



PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650	)
R <sub>DS(on)</sub> max. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	0.28
Q <sub>g</sub> max. (nC)	76	
Q <sub>gs</sub> (nC)	11	
Q <sub>gd</sub> (nC)	17	
Configuration	Sing	le

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

## **APPLICATIONS**

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Consumer
  - Adaptors
  - Televisions
  - Game console
- Computing
  - Adaptors
  - ATX power supply

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA15N60E-E3
Lead (Pb)-free and halogen-free	SiHA15N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	600	V	
Gate-source voltage		$V_{GS}$	± 30	7 V	
Continuous drain surrent (T = 150 °C) e	V at 10 V	T <sub>C</sub> = 25 °C	1	15	
Continuous drain current (T <sub>J</sub> = 150 °C) e		T <sub>C</sub> = 100 °C	I <sub>D</sub>	9.6	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	39	
Linear derating factor			0.27	W/°C	
Single pulse avalanche energy b		E <sub>AS</sub>	102	mJ	
Maximum power dissipation		$P_{D}$	34	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	$V_{DS} = 0 V t$	o 80 % V <sub>DS</sub>	-11.//-14	70	1//
Reverse diode dV/dt d	verse diode dV/dt d 7.7		- V/ns		
Soldering recommendations (peak temperature) c	for	10 s		300	°C
Mounting torque M3 screw			0.6	Nm	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 11.6 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 4.2 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , dI/dt = 100 A/µs, starting  $T_{.I} = 25 \, ^{\circ}\text{C}$
- e. Limited by maximum junction temperature



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# Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	$R_{thJA}$	-	65	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	-	3.7	C/ VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.71	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V	-	_	± 1	μΑ
			= 600 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	$I_{DSS}$		/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8 A		0.23	0.28	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 8 A		-	4.6	-	S
Dynamic				ļ.	Į.		
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		_	1350	-	pF
Output capacitance	C <sub>oss</sub>				70	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-	
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$	V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	53	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	177	-	
Total gate charge	Qg			-	38	76	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 8 A, V_{DS} = 480 V$	-	11	-	nC
Gate-drain charge	$Q_{gd}$			-	17	-	
Turn-on delay time	t <sub>d(on)</sub>	·		-	17	34	
Rise time	t <sub>r</sub>	Vpp	= 480 V, I <sub>D</sub> = 8 A,	-	51	77	]
Turn-off delay time	t <sub>d(off)</sub>		$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		35	70	ns
Fall time	t <sub>f</sub>	<u> </u>		-	33	66	
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.3	0.86	1.7	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	^
Pulsed diode forward current	I <sub>SM</sub>			-	-	60	- A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 8 A, V <sub>GS</sub> = 0 V		-	1.2	V
Reverse recovery time	t <sub>rr</sub>	-		-	410	-	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 8 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 20 \text{ V}$		-	5.4	-	μC
Reverse recovery current	I <sub>RRM</sub>			_	21	_	A

#### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

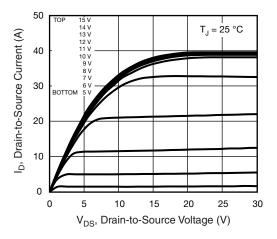


Fig. 1 - Typical Output Characteristics

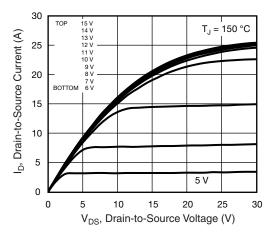


Fig. 2 - Typical Output Characteristics

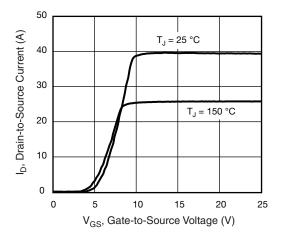


Fig. 3 - Typical Transfer Characteristics

S17-1307-Rev. E, 21-Aug-17

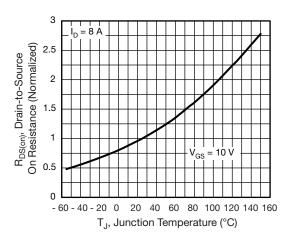


Fig. 4 - Normalized On-Resistance vs. Temperature

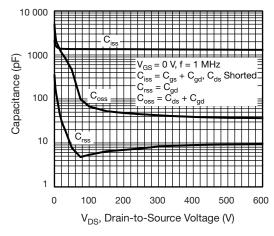


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

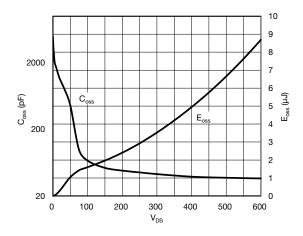


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 



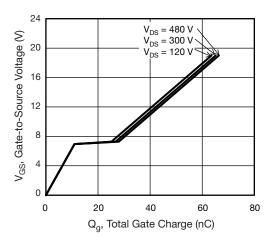


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

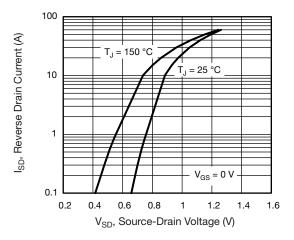


Fig. 8 - Typical Source-Drain Diode Forward Voltage

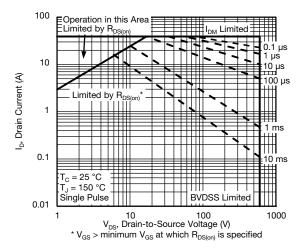


Fig. 9 - Maximum Safe Operating Area

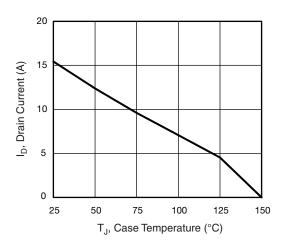


Fig. 10 - Maximum Drain Current vs. Case Temperature

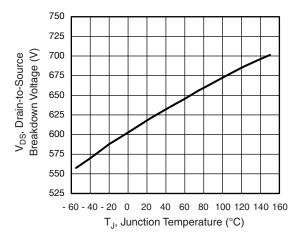


Fig. 11 - Temperature vs. Drain-to-Source Voltage



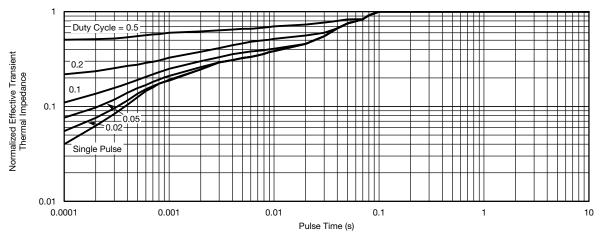


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

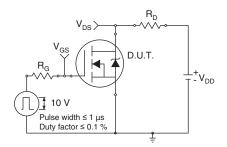


Fig. 13 - Switching Time Test Circuit

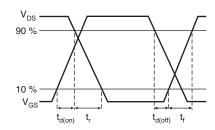


Fig. 14 - Switching Time Waveforms

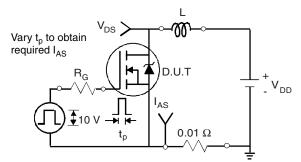


Fig. 15 - Unclamped Inductive Test Circuit

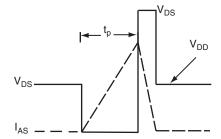


Fig. 16 - Unclamped Inductive Waveforms

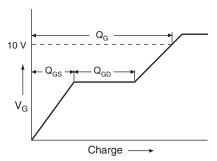


Fig. 17 - Basic Gate Charge Waveform

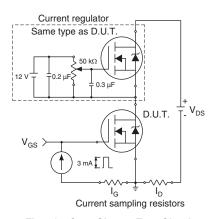
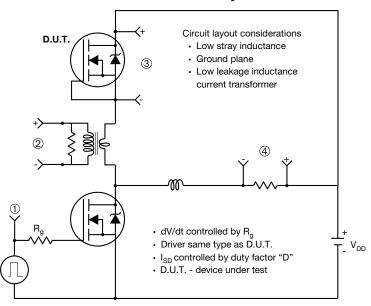


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



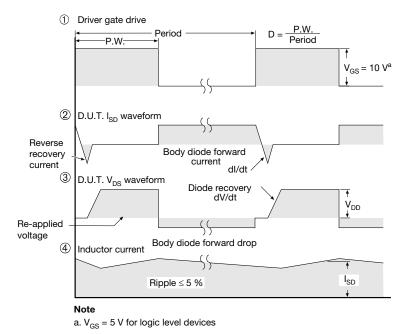


Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





SYMBOL		DIMEN	ISIONS	
	MILLIN	IETERS	INCHE	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
Е	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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Vishay

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